

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S46	8	S45 and (@ad<"20040130" or @riad<"20040130")	US-PGPUB; USPAT	OR	ON	2005/12/13 17:03
S196	88	S195 and (("257"/\$3.cor.) or ("438"/\$3.cor.))	US-PGPUB; USPAT	OR	ON	2005/12/13 17:03
S197	35	S196 and (cu or copper)	US-PGPUB; USPAT	OR	ON	2005/12/13 17:03
S198	11	S197 and damascene	US-PGPUB; USPAT	OR	ON	2005/12/13 17:03
S199	9	S198 and (@ad<"20040130" or @riad<"20040130")	US-PGPUB; USPAT	OR	ON	2005/12/13 17:04
S200	3	"6465352"	US-PGPUB; USPAT	OR	ON	2005/12/13 17:04
S201	3	S200 and (@ad<"20040130" or @riad<"20040130")	US-PGPUB; USPAT	OR	ON	2005/12/13 17:04
S195	190	((plasma near2 after) with wet)	US-PGPUB; USPAT	OR	ON	2005/12/14 19:05
S10	0	S8 and (((cu or copper or cupric) adj oxide) with ((reduce or reduction or reduced) adj (cu or copper)))	US-PGPUB; USPAT	OR	ON	2005/12/14 19:06
S13	300	S12 and (@ad<"20040130" or @riad<"20040130")	US-PGPUB; USPAT	OR	ON	2005/12/14 19:06
S202	82	((plasma near hydrogen) with (cu or copper or cupric) with oxide)	US-PGPUB; USPAT	OR	ON	2005/12/14 19:25
S204	38	S203 and (@ad<"20040130" or @riad<"20040130")	US-PGPUB; USPAT	OR	ON	2005/12/14 19:25
S203	39	S202 and (((cu or copper or cupric) adj oxide) with ((reduce or reduction or reduced) adj (cu or copper)))	US-PGPUB; USPAT	OR	ON	2005/12/14 19:39
S210	4	((((cu or copper or cupric) adj oxide) with etchant with barrier)	US-PGPUB; USPAT	OR	ON	2005/12/14 19:40
S212	50	"6323121"	US-PGPUB; USPAT	OR	ON	2005/12/14 19:44
S211	3	((cu or copper) with barrier with (etch or etched or etching or etchant) with (fluorocarbon))	US-PGPUB; USPAT	OR	ON	2005/12/14 19:47
S206	28	((plasma near hydrogen) with (cu or copper or cupric) with oxide) and ((plasma near hydrogen) with after)	US-PGPUB; USPAT	OR	ON	2005/12/14 19:48
S207	28	S206 and (@ad<"20040130" or @riad<"20040130")	US-PGPUB; USPAT	OR	ON	2005/12/14 19:48
S214	59	S213 and (@ad<"20040130" or @riad<"20040130")	US-PGPUB; USPAT	OR	ON	2005/12/14 19:48
S215	0	((plasma near hydrogen) with (cu or copper or cupric) with oxide) and ((plasma near hydrogen) with after) and S214	US-PGPUB; USPAT	OR	ON	2005/12/14 19:48
S216	0	((plasma near hydrogen) with (cu or copper or cupric) with oxide) and S214	US-PGPUB; USPAT	OR	ON	2005/12/14 19:48
S217	0	(plasma with hydrogen with (cu or copper or cupric) with oxide) and S214	US-PGPUB; USPAT	OR	ON	2005/12/14 19:48
S218	0	(plasma with hydrogen with (cu or copper or cupric)) and S214	US-PGPUB; USPAT	OR	ON	2005/12/14 19:48
S219	22	(plasma with hydrogen) and S214	US-PGPUB; USPAT	OR	ON	2005/12/14 19:48
S213	64	(barrier with (etch or etched or etching or etchant) with (fluorocarbon))	US-PGPUB; USPAT	OR	ON	2005/12/14 19:49

S22 0	6	(plasma with hydrogen with oxide) and S214	US-PGPUB; USPAT	OR	ON	2005/12/14 19:49
S22 1	0	(plasma with hydrogen with (cu or copper)) and S214	US-PGPUB; USPAT	OR	ON	2005/12/14 19:49
S22 2	410	(plasma with hydrogen with (cu or copper))	US-PGPUB; USPAT	OR	ON	2005/12/14 19:59
S22 3	15	(barrier with (etch or etched or etching or etchant) with (fluorocarbon or oxygen or "o.sub.2" or "cf.sub.2")) and S222	US-PGPUB; USPAT	OR	ON	2005/12/14 19:59
S22 4	6	("20030181031" "6323121" "6787462").PN. or ("6569777" "6677247" "6730594").PN.	US-PGPUB; USPAT	OR	ON	2005/12/14 19:59
S22 5	1	(plasma with hydrogen with (cu or copper)) and S224	US-PGPUB; USPAT	OR	ON	2005/12/14 20:00
S22 6	3	(plasma with (hydrogen or "h.sub.2")) and S224	US-PGPUB; USPAT	OR	ON	2005/12/14 20:00